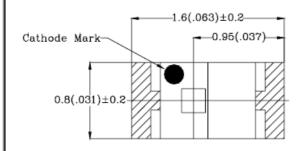
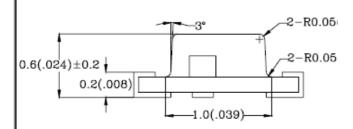
0603 Package Bluish Green SMD Chip LED Lamps (0.6mm Height)

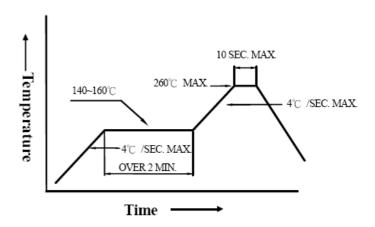
Part Number: AL-HG436A

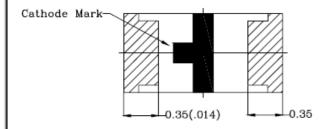
Package outlines & Re-flow Profile





■Reflow Temp/Time



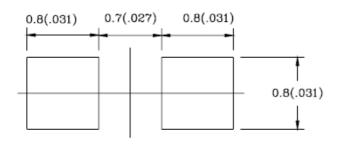


■Soldering iron

Basic spec is \leq 5sec when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1sec). Power dissipation of iron should be smaller than 15W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

ITEM	MATERIALS
Resin (mold)	Ероху
Lens color	Water Clear
Printed circuit board	BT
Dice	InGaN
Emitted color	Bluish Green

For Reflow Soldering



NOTES:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

Part Number: AL-HG436A

ELECTRO-OPTICAL CHARACTERISTICS					(T _A =25°℃)	
Parameter		Test Condition	Symbol	Value	Unit	
Viewing angle at 50% l√		I _F =10mA	2 <i>0</i> 1/2	120	Deg	
(T Forward voltage	ур.)	I _F =20mA	V _F	3.50	V	
	lax.)	IF-ZUIIIA		4.00		
Luminous intensity (N	Min.)	I _F =20mA	l _V	63.0	mcd	
	Гур.)	IF-ZUIIIA	Iγ	120.0	IIICu	
Wayalanath		I₅=20mA	λр	505	nm	
Wavelength		IF-ZUIIIA	λd	505±5	nm	
Spectral Line Half-Width		I _F =20mA	$ riangle \lambda$	30	nm	
Peak pulsing current (1/10 duty f=1kHz)			I _{FP}	100	mA	

Absolute maximum ratings			T _A =25°C)	
Parameter	Symbol	Value	Unit	
Forward current	l _F	30	mA	
Reverse voltage	V _R	5	V	
Reverse current	I _R	100	μΑ	
Power Dissipation	P _D	100	mW	
Operating temperature range	Тор	-25 ~+80	$^{\circ}\!\mathbb{C}$	
Storage temperature range	Tstg	-30 ~+85	$^{\circ}\!\mathbb{C}$	
Lead soldering temperature	260°C For 5 Seconds			

Part Number: AL-HG436A

Test items and results of reliability

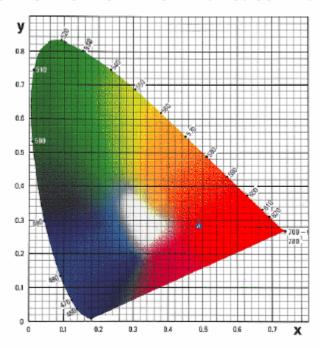
Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	Connect with a power If=20mA Ta=Under room temperature Test time=1,000hrs	0/20
Endurance Test	. '	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+65°C±5°C RH=90%-95% Test time=240hrs	0/20
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-35°C ±5°C Test time=1,000hrs	0/20
	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	-35 $^{\circ}$ C ~ +25 $^{\circ}$ C ~ +85 $^{\circ}$ C ~ +25 $^{\circ}$ C 60min 20min 60min 20min Test Time=5cycle	0/20
Environmental Test	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-35°C±5°C ∼+85°C±5°C 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating: 140℃-160℃,within 2 minutes. Operation heating: 260℃(Max.), within 10seconds. (Max.)	0/20

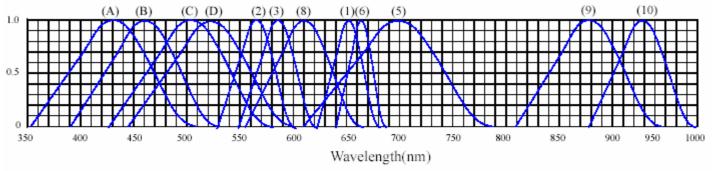
^{*}Refer to reliability test standard specification for in this line.

Part Number: AL-HG436A

Typical Optical-Electrical Characteristic Curves

◆ TYPICAL ELECTRICAL-OPTICAL CHARACTERISTICS CURVES





RELATIVE INTENSITY VS. WAVELENGTH(λp)

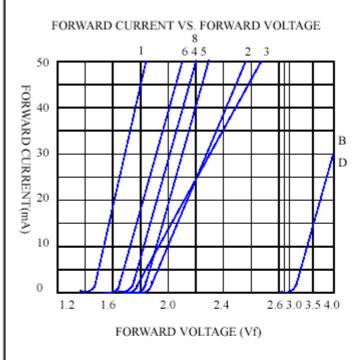
- (1) GaAsP/GaAs 655nm/Red
- (2) GaP 568nm/ Yellow Green
- (3) GaAsP/GaP 585nm/Yellow
- (4) GaAsP/GaP 635nm/Orange & Hi-Eff Red
- (5) GaP 700nm/Bright Red
- (6) GaAlAs/GaAs 660nm/Super Red
- (8) GaAsP/GaP 610nm/Super Red

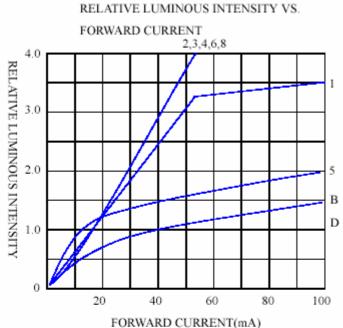
- (9)- GaAlAs 880nm
- (10)-GaAs/GaAs&GaAlAs/GaAs 940nm
- (A)- GaN 430nm/Blue
- (B)- InGaN 470nm/Blue
- (C)- InGaN 502nm/Ultra Green
- (D)- InGaN 523nm/Ultra Green

Part Number: AL-HG436A

Typical Optical-Electrical Characteristic Curves

♦ CHARACTERISTICS DIAGRAMS





TEMPERATURE 50 1 6 2,4,8 A 3 5 10 20 40 6 20 40 6 AMBIENT TEMPERATURE Ta(°C)

FORWARD CURRENT VS. AMBIENT

